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NPN/PNP resistor-equipped transistors; R1 = 22 kΩ, R2 = 22 kΩ

Rev. 8 — 14 November 2013

**Product data sheet** 

### 1. Product profile

#### **1.1 General description**

NPN/PNP double Resistor-Equipped Transistors (RET) in Surface-Mounted Device (SMD) plastic packages.

Table 1.	Product	overview
	1 I Oudot	010111011

Type number	Package		PNP/PNP	NPN/NPN	Package
	NXP	JEITA	complement	complement	configuration
PEMD2	SOT666	-	PEMB1	PEMH1	ultra small and flat lead
PIMD2	SOT457	SC-74	-	-	small
PUMD2	SOT363	SC-88	PUMB1	PUMH1	very small

### **1.2 Features and benefits**

- 100 mA output current capability
   Reduces component count
- Built-in bias resistors
- Simplifies circuit design

#### 1.3 Applications

- Low current peripheral driver
- Control of IC inputs
- Replaces general-purpose transistors in digital applications

### 1.4 Quick reference data

Table 2.	Quick reference data					
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Per trans	istor; for the PNP transistor	with negative po	olarity			
V <sub>CEO</sub>	collector-emitter voltage	open base	-	-	50	V
lo	output current		-	-	100	mA
R1	bias resistor 1 (input)		15.4	22	28.6	kΩ
R2/R1	bias resistor ratio		0.8	1	1.2	



- Reduces pick and place costs
- AEC-Q101 qualified

### NPN/PNP resistor-equipped transistors; R1 = 22 k $\Omega$ , R2 = 22 k $\Omega$

### 2. Pinning information

Pin	Description	Simplified outline	Graphic symbol
PEMD2	(SOT666); PUMD2 (SOT363)		
1	GND (emitter) TR1		
2	input (base) TR1	6 5 4	
3	output (collector) TR2		
4	GND (emitter) TR2		
5	input (base) TR2		
6	output (collector) TR1	001aab555	

PIMD2	(SOT457)	
1	GND (emitter) TR2	o 5 4
2	input (base) TR2	
3	output (collector) TR1	
4	GND (emitter) TR1	
5	input (base) TR1	
6	output (collector) TR2	

006aab235

2 006aaa143

1

### 3. Ordering information

Table 4.         Ordering information					
Type number Package					
	Name	Description	Version		
PEMD2	-	plastic surface-mounted package; 6 leads	SOT666		
PIMD2	SC-74	plastic surface-mounted package (TSOP6); 6 leads	SOT457		
PUMD2	SC-88	plastic surface-mounted package; 6 leads	SOT363		

### 4. Marking

Table 5.	Marking	codes
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Type number	Marking code <sup>[1]</sup>
PEMD2	D4
PIMD2	M5
PUMD2	D*2

[1] \* = placeholder for manufacturing site code

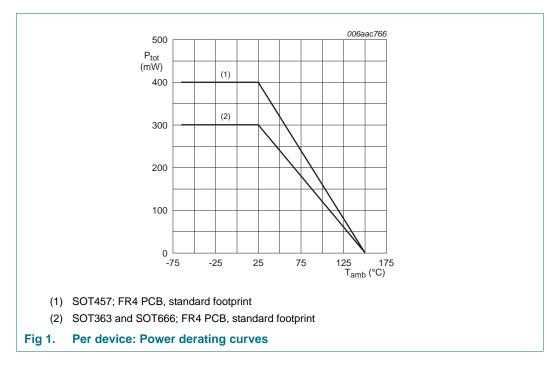
### NPN/PNP resistor-equipped transistors; R1 = 22 k $\Omega$ , R2 = 22 k $\Omega$

### 5. Limiting values

Symbol	Parameter	Conditions	Min	Max	Unit
Per transis	stor; for the PNP transistor	with negative polarity	/		
V <sub>CBO</sub>	collector-base voltage	open emitter	-	50	V
V <sub>CEO</sub>	collector-emitter voltage	open base	-	50	V
V <sub>EBO</sub>	emitter-base voltage	open collector	-	10	V
VI	input voltage TR1				
	positive		-	+40	V
	negative		-	-10	V
	input voltage TR2				
	positive			+10	
	negative			-40	
lo	output current		-	100	mA
I <sub>CM</sub>	peak collector current	single pulse; $t_p \leq 1 \text{ ms}$	-	100	mA
P <sub>tot</sub>	total power dissipation	$T_{amb} \le 25 \ ^{\circ}C$			
	PEMD2 (SOT666)		<u>[1]</u> -	200	mW
	PIMD2 (SOT457)		<u>[1]</u>	250	mW
	PUMD2 (SOT363)		<u>[1]</u> -	200	mW
Per device	)				
P <sub>tot</sub>	total power dissipation	$T_{amb} \le 25 \ ^{\circ}C$			
	PEMD2 (SOT666)		<u>[1]</u> -	300	mW
	PIMD2 (SOT457)		<u>[1]</u>	400	mW
	PUMD2 (SOT363)		<u>[1]</u> -	300	mW
Tj	junction temperature		-	150	°C
T <sub>amb</sub>	ambient temperature		-55	+150	°C
T <sub>stg</sub>	storage temperature		-65	+150	°C

[1] Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided copper, tin-plated and standard footprint.

NPN/PNP resistor-equipped transistors; R1 = 22 k $\Omega$ , R2 = 22 k $\Omega$ 

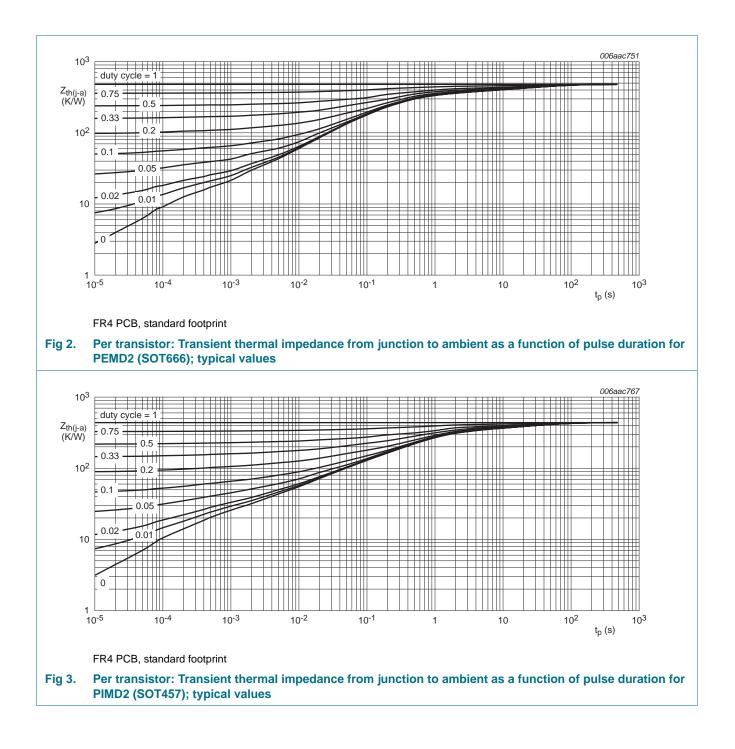


### 6. Thermal characteristics

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Per transis	stor					
R <sub>th(j-a)</sub>	thermal resistance from junction to ambient	in free air				
	PEMD2 (SOT666)		<u>[1]</u> -	-	625	K/W
	PIMD2 (SOT457)		<u>[1]</u> -	-	500	K/W
	PUMD2 (SOT363)		<u>[1]</u> -	-	625	K/W
Per device	)					
R <sub>th(j-a)</sub>	thermal resistance from junction to ambient	in free air				
	PEMD2 (SOT666)		<u>[1]</u> -	-	417	K/W
	PIMD2 (SOT457)		<u>[1]</u> -	-	313	K/W
	PUMD2 (SOT363)		<u>[1]</u> -	-	417	K/W

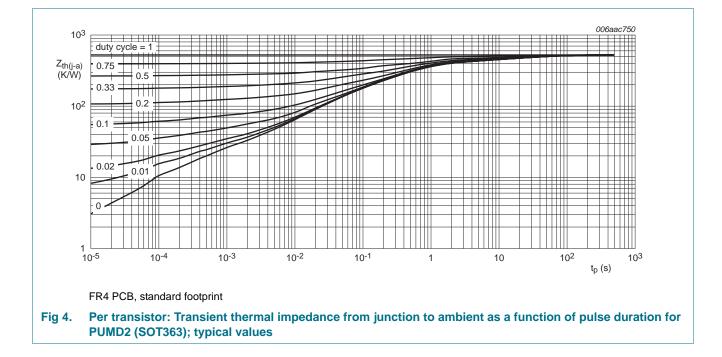
[1] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.

### PEMD2; PIMD2; PUMD2



### PEMD2; PIMD2; PUMD2

NPN/PNP resistor-equipped transistors; R1 = 22 k $\Omega$ , R2 = 22 k $\Omega$ 



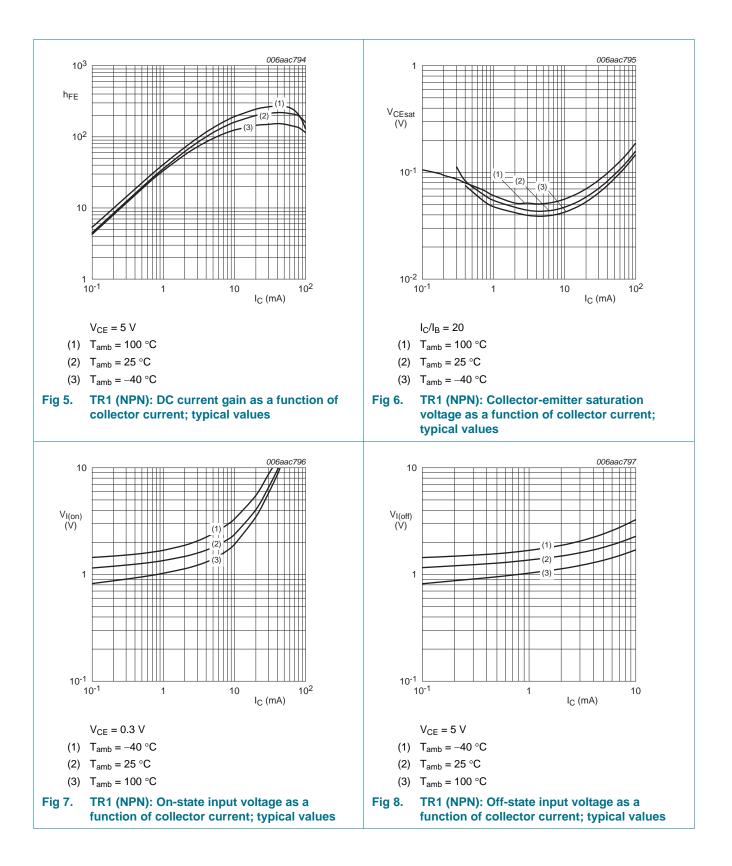
### NPN/PNP resistor-equipped transistors; R1 = 22 k $\Omega$ , R2 = 22 k $\Omega$

### 7. Characteristics

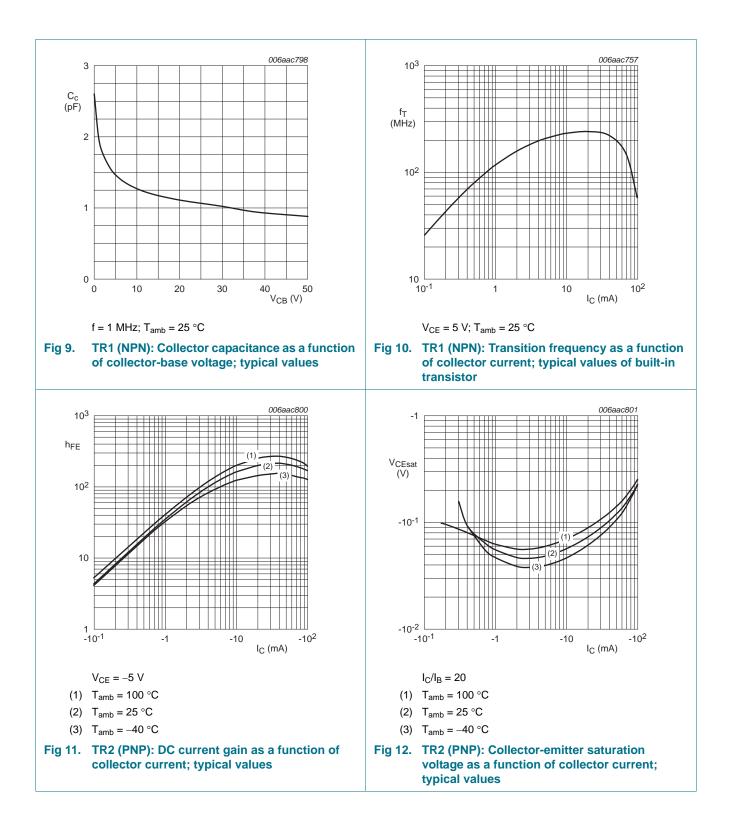
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Per trans	sistor; for the PNP trans	sistor with negative polarity				
I <sub>CBO</sub>	collector-base cut-off current	$V_{CB} = 50 \text{ V}; \text{ I}_{E} = 0 \text{ A}$	-	-	100	nA
I <sub>CEO</sub>	CEO collector-emitter cut-off	$V_{CE} = 30 \text{ V}; I_B = 0 \text{ A}$	-	-	100	nA
	current	$V_{CE} = 30 \text{ V}; \text{ I}_{B} = 0 \text{ A};$ T <sub>j</sub> = 150 °C	-	-	5	μΑ
I <sub>EBO</sub>	emitter-base cut-off current	$V_{EB} = 5 V; I_{C} = 0 A$	-	-	180	μA
h <sub>FE</sub>	DC current gain	$V_{CE} = 5 \text{ V}; I_{C} = 5 \text{ mA}$	60	-	-	
V <sub>CEsat</sub>	collector-emitter saturation voltage	$I_{C}$ = 10 mA; $I_{B}$ = 0.5 mA	-	-	150	mV
V <sub>I(off)</sub>	off-state input voltage	$V_{CE}$ = 5 V; $I_C$ = 100 $\mu$ A	-	1.1	0.8	V
V <sub>I(on)</sub>	on-state input voltage	$V_{CE} = 0.3 \text{ V}; I_{C} = 5 \text{ mA}$	2.5	1.7	-	V
R1	bias resistor 1 (input)		15.4	22	28.6	kΩ
R2/R1	bias resistor ratio		0.8	1	1.2	
C <sub>c</sub>	collector capacitance	$V_{CB} = 10 \text{ V}; I_E = i_e = 0 \text{ A};$ f = 1 MHz				
	TR1 (NPN)		-	-	2.5	pF
	TR2 (PNP)		-	-	3	
f <sub>T</sub>	transition frequency	$V_{CE} = 5 V; I_C = 10 mA;$ [1] f = 100 MHz				
	TR1 (NPN)		-	230	-	MHz
	TR2 (PNP)		-	180	-	MHz

[1] Characteristics of built-in transistor

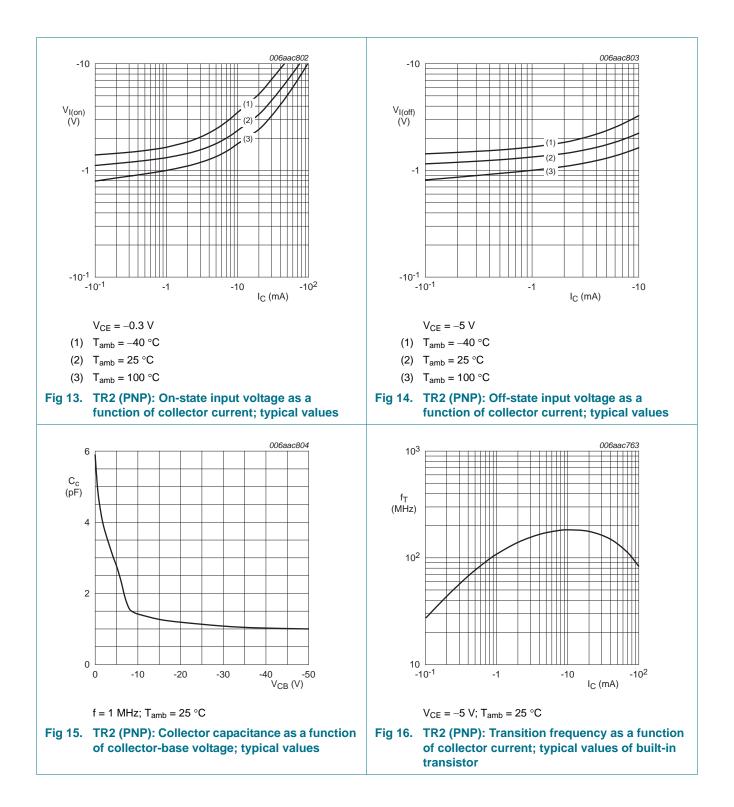
# PEMD2; PIMD2; PUMD2



# PEMD2; PIMD2; PUMD2



### PEMD2; PIMD2; PUMD2



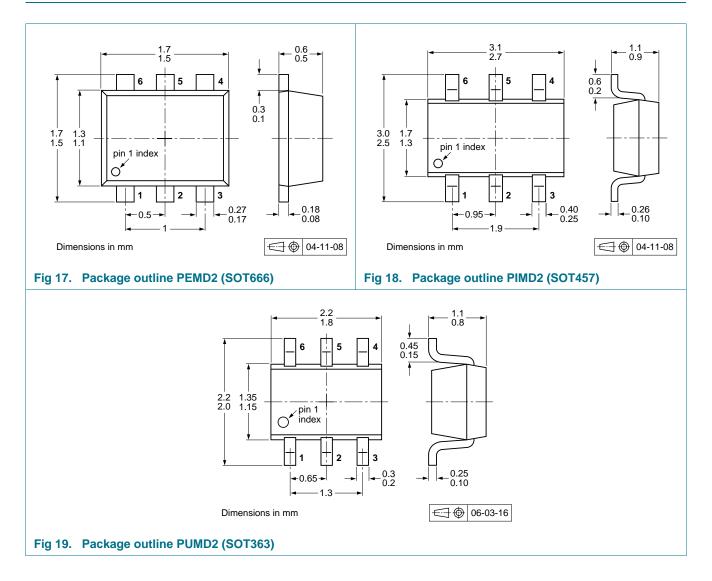
NPN/PNP resistor-equipped transistors; R1 = 22 k $\Omega$ , R2 = 22 k $\Omega$ 

### 8. Test information

#### 8.1 Quality information

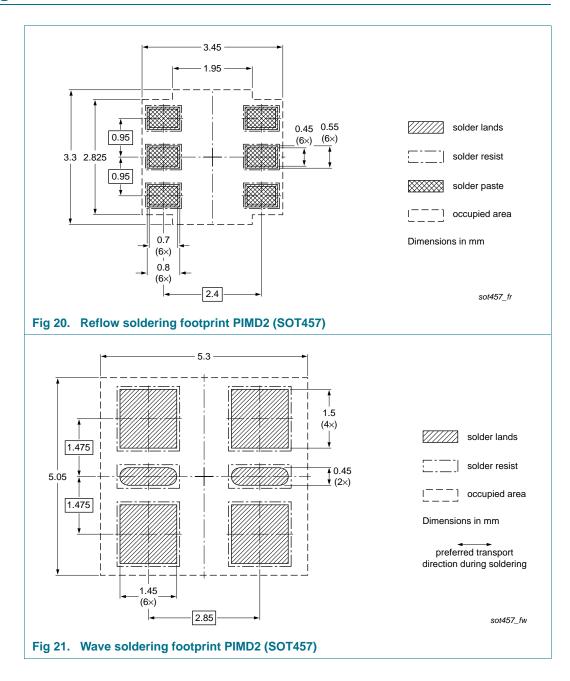
This product has been qualified in accordance with the Automotive Electronics Council (AEC) standard *Q101* - *Stress test qualification for discrete semiconductors*, and is suitable for use in automotive applications.

### 9. Package outline

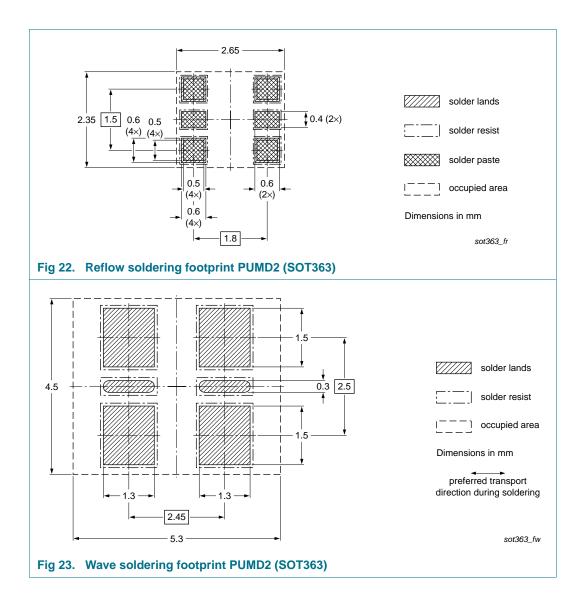


NPN/PNP resistor-equipped transistors; R1 = 22 k $\Omega$ , R2 = 22 k $\Omega$ 

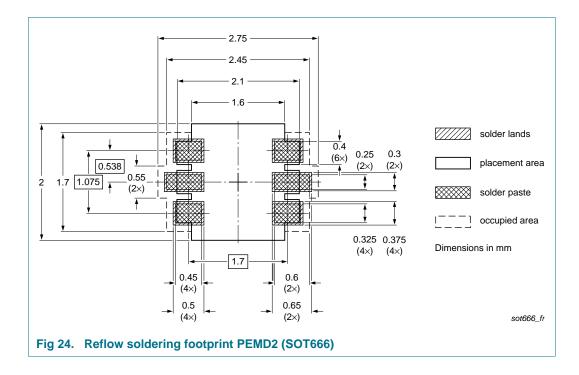
### **10. Soldering**



NPN/PNP resistor-equipped transistors; R1 = 22 k $\Omega$ , R2 = 22 k $\Omega$ 



NPN/PNP resistor-equipped transistors; R1 = 22 k $\Omega$ , R2 = 22 k $\Omega$ 



NPN/PNP resistor-equipped transistors; R1 = 22 k $\Omega$ , R2 = 22 k $\Omega$ 

### 11. Revision history

#### Table 9.Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes
PEMD2_PIMD2_PUMD2 v.8	20131114	Product data sheet	-	PEMD2_PIMD2_PUMD2 v.7
Modifications:	Section 1 '	"Product profile": updated	1	
	<ul> <li>Section 4 '</li> </ul>	"Marking": updated		
	<ul> <li>Figure 1 to</li> </ul>	9 <u>4, 9</u> , <u>10</u> , <u>15</u> and <u>16</u> : add	ed	
	Section 5 '	"Limiting values": updated	b	
	Section 6 <sup>c</sup>	"Thermal characteristics"	updated	
	• Figure 5 to	8 and <u>11</u> to <u>14</u> : updated		
	• Table 8 "C	haracteristics": I <sub>CEO</sub> upda	ated, f <sub>T</sub> added	
	<ul> <li>Section 8 '</li> </ul>	"Test information": added		
	Section 12	<u>"Legal information</u> ": upd	ated	
PEMD2_PIMD2_PUMD2 v.7	20080924	Product data sheet	-	PEMD2_PIMD2_PUMD2 v.6
PEMD2_PIMD2_PUMD2 v.6	20042104	Product specification	-	PEMD2_PIMD2_PUMD2 v.5
PEMD2_PIMD2_PUMD2 v.5	20030606	Product specification	-	-

NPN/PNP resistor-equipped transistors; R1 = 22 k $\Omega$ , R2 = 22 k $\Omega$ 

### **12. Legal information**

#### 12.1 Data sheet status

Document status[1][2]	Product status <sup>[3]</sup>	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

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[2] The term 'short data sheet' is explained in section "Definitions".

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# PEMD2; PIMD2; PUMD2

#### NPN/PNP resistor-equipped transistors; R1 = 22 k $\Omega$ , R2 = 22 k $\Omega$

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# PEMD2; PIMD2; PUMD2

NPN/PNP resistor-equipped transistors; R1 = 22 k $\Omega$ , R2 = 22 k $\Omega$ 

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